

PLEASE CHECK WWW.MOLEX.COM FOR LATEST PART INFORMATION

Part Number:

0432496107

Status:

Active

Overview:

modular_plugs_jacks

Description:

Modular Jack, Right Angle, Low Profile, 6/2, Flangeless

Documents:

- 3D Model

Product Specification PSX-43249 (PDF)
- Drawing (PDF)

RoHS Certificate of Compliance (PDF)

Agency Certification

CSA

LR19980

UL

E107635

General

Product Family

Modular Jacks/Plugs

Series

43249

Component Type

PCB Jack

Magnetic

No

Overview

modular_plugs_jacks

Performance Category

3

Power over Ethernet (PoE)

N/A

Product Name

RJ11

Physical

Boot Color

N/A

Color - Resin

Black

Durability (mating cycles max)

500

Flammability

94V-0

Inverted / Top Latch

No

Lightpipes/LEDs

None

Material - Metal

Phosphor Bronze

Material - Plating Mating

Gold

Material - Plating Termination

Tin

Material - Resin

High Temperature Thermoplastic

Orientation

Right Angle (Side Entry)

PCB Locator

Yes

PCB Retention

Yes

PCB Thickness Recommended (in)

0.062 In

PCB Thickness Recommended (mm)

1.57 mm

Packaging Type

Tray

Pitch - Mating Interface (in)

0.040 In

Pitch - Mating Interface (mm)

1.02 mm

Pitch - Term. Interface (in)

0.050 In

Pitch - Term. Interface (mm)

1.27 mm

Plating min: Mating (µin)

50

Plating min: Mating (µm)

1.25

Plating min: Termination (µin)

100

Plating min: Termination (µm)

2.5

Ports

1

Positions / Loaded Contacts

6/2

Surface Mount Compatible (SMC)

Yes

Temperature Range - Operating

-40°C to +85°C

Termination Interface: Style

Through Hole

Waterproof / Dustproof

No

Wire/Cable Type

N/A

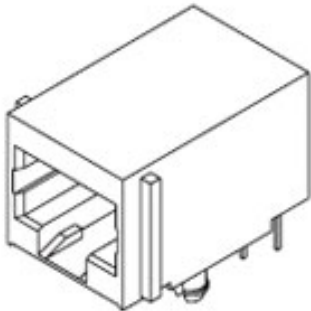


image - Reference only

Series

EU RoHS

ELV and RoHS
Compliant
REACH SVHC
Not Reviewed
Halogen-Free
Status

China RoHS



Need more information on product
environmental compliance?

Email productcompliance@molex.com
For a multiple part number RoHS Certificate of
Compliance, [click here](#)

Please visit the [Contact Us](#) section for any
non-product compliance questions.

Search Parts in this Series
43249Series

Mates With
FCC 68 Plugs

Electrical

Current - Maximum per Contact	1.5A
Grounding to Panel	N/A
Shielded	No
Voltage - Maximum	150V AC (RMS)

Solder Process Data

Lead-free Process Capability	Wave Capable (TH only)
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Material Info

Reference - Drawing Numbers

Packaging Specification	PK-43249-004
Product Specification	PSX-43249
Sales Drawing	SDA-43249

This document was generated on 06/07/2010

PLEASE CHECK WWW.MOLEX.COM FOR LATEST PART INFORMATION

NOTES:

1) MATERIAL:

HOUSING: NYLON(PA), GLASS FILLED, UL94V-0, COLOR: BLACK
 INSULATOR: NYLON(PA), GLASS FILLED, UL94V-0, COLOR: BLACK
 TERMINALS: PHOSPHOR BRONZE, .012/(0.30) THICK
 SHIELD: BRASS, .007/(0.18) THICK

2) FINISH:

TERMINALS:

- A = SELECT GOLD IN CONTACT AREA: 50 MICROINCHES / 1.27 MICROMETERS MIN.,
 *SELECT TIN IN PC TAIL AREA: 100 MICROINCHES / 2.54 MICROMETERS MIN.,
 WITH OVERALL NICKEL UNDERPLATE: 50 MICROINCHES / 1.27 MICROMETERS MIN.
 B = SELECT GOLD IN CONTACT AREA: 30 MICROINCHES / 0.76 MICROMETERS MIN.,
 *SELECT TIN IN PC TAIL AREA: 100 MICROINCHES / 2.54 MICROMETERS MIN.,
 WITH OVERALL NICKEL UNDERPLATE: 50 MICROINCHES / 1.27 MICROMETERS MIN.

SHIELD:

- *100 MICROINCHES / 2.54 MICROMETERS NICKEL OVER 50 MICROINCHES /
 1.27 MICROMETERS COPPER UNDERPLATE, PCB GROUND TABS DIPPED IN TIN
 *THE PRIMARY SHIPPING CARTON WILL BE LABELED "COMPLIANT TO RoHS
 DIRECTIVE 2002/95/EC AND ELV ANNEX II OF DIRECTIVE 2000/53/EC".
 CARTONS WITHOUT THIS LABEL MAY CONTAIN PRODUCT WITH TIN-LEAD
 IN THE PC TAILS AND/OR SHIELD.

3) PRODUCT SPECIFICATION AND PROCESSING PARAMETERS: PS-43249.

4) PACKAGING SPECIFICATION:

- UNSHIELDED CONNECTOR ASSEMBLIES PACKAGED IN THERMOFORMED TRAYS
 PER MOLEX PACKAGING SPECIFICATION PK-43249-004.
 UNSHIELDED CONNECTOR ASSEMBLIES PACKAGED IN TUBES
 PER MOLEX PACKAGING SPECIFICATION PK-43249-005.
 SHIELDED CONNECTOR ASSEMBLIES PACKAGED IN THERMOFORMED TRAYS
 PER MOLEX PACKAGING SPECIFICATION PK-44050-004.

5) MATES WITH: MODULAR PLUGS THAT CONFORM TO FCC REGULATION PART 68.5.

6) SEE SHEET 3 FOR SHIELDED JACK ASSEMBLY.

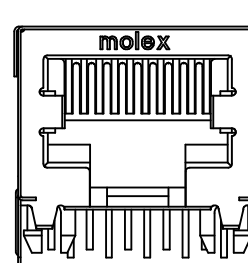
7) SEE SHEETS 5 & 6 FOR P.C. BOARD LAYOUTS.

8) ALL UNTOLERANCED DIMENSIONS ARE SHOWN FOR REFERENCE ONLY.

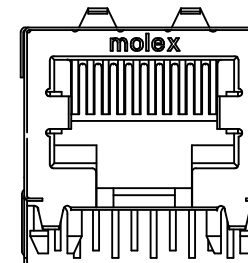
9) THIS PART CONFORMS TO CLASS B REQUIREMENTS OF COSMETIC SPECIFICATION PS-45499-002.

10) THIS PART CONFORMS TO FCC REGULATION 68.5 AND TIA 1096 FOR MODULAR JACKS.

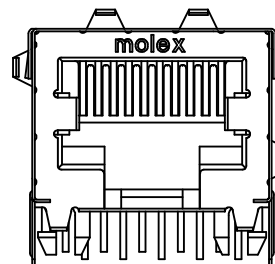
SIDE/TOP GROUND TAB OPTIONS FOR SHIELDS



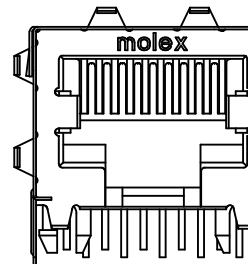
OPTION "A"
NO TOP OR SIDE TABS



OPTION "B"
TOP TABS

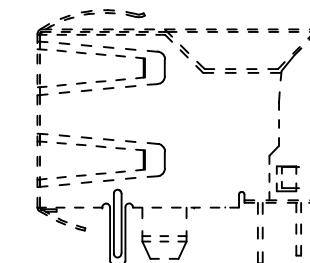


OPTION "C"
TOP AND STAGGERED SIDE TABS

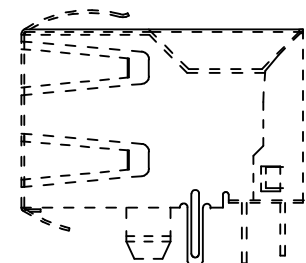


OPTION "D"
TOP AND SIDE TABS

BOTTOM PCB GROUND TAB OPTIONS FOR SHIELDS



OPTION "E"
OPTIONAL FRONT POSITION



OPTION "F"
OPTIONAL REAR POSITION

NOTE: EITHER PCB GROUND TAB OPTION IS AVAILABLE
ON ALL SIDE/TOP TAB CONFIGURATIONS

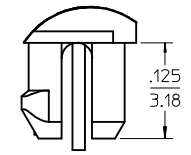
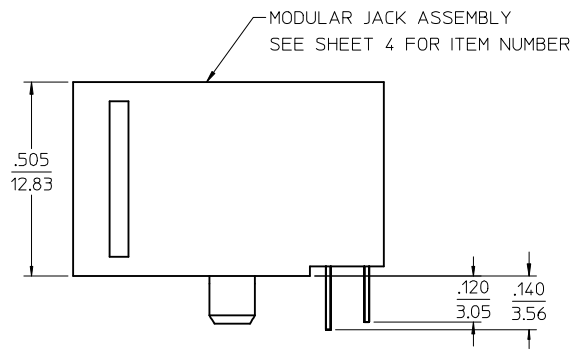
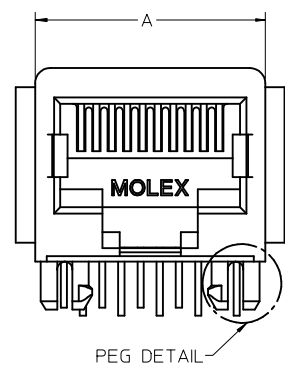
DRAWING LEGEND

- SHEET 1- NOTES, GROUND TAB OPTIONS
 SHEET 2- UNSHIELDED MODULAR JACK
 SHEET 3- SHIELDED MODULAR JACK WITH
 OPTIONAL SIDE/TOP GROUND TABS & BOTTOM GROUND
 TAB WITH OPTIONAL POSITION.
 SHEET 4- PART NUMBER CHARTS
 SHEET 5- FOOTPRINT LAYOUT FOR 8 POSITION HOUSING
 SHEET 6- FOOTPRINT LAYOUT FOR 6 POSITION HOUSING

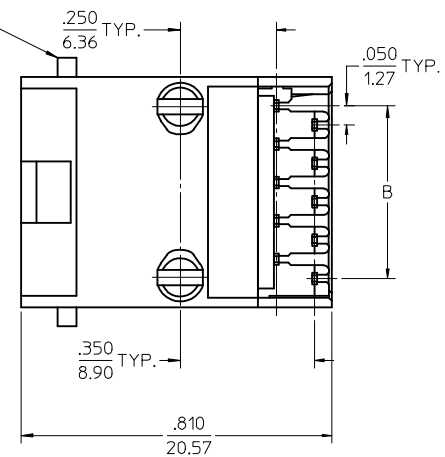
ADDED NOTE 10 EC NO: UCP2009-0740 DRWN: KLOSTERER 2008/09/29 CHKD: JEBELL 2008/10/03 APPR: FSMITH 2008/10/03	DESCRIPTION	QUALITY SYMBOLS ▽=0 ▽=0	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE IN/MM		SCALE 4:1	DESIGN UNITS INCH	 THIRD ANGLE PROJECTION			
				mm	INCH	DRAWN BY JTR		DATE 1993/06/23		TITLE LOW PROFILE RIGHT ANGLE MODULAR JACK ASSEMBLY		
		4 PLACES	± .005	± .005	CHECKED BY JTR		DATE 1993/06/23	MOLEX MOLEX INCORPORATED				
		3 PLACES	± .005	± .010	APPROVED BY RAS		DATE 1993/06/23					
		2 PLACES	± 0.25	± .005	MATERIAL NO. SEE SHEET 4		DOCUMENT NO. SDA-43249			SHEET NO. 1 OF 6		
		1 PLACE	± .005	± .005	SIZE C		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION					
		ANGULAR ±1/2°										
		DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS										
		REV K1										

UNSHIELDED MODULAR JACK

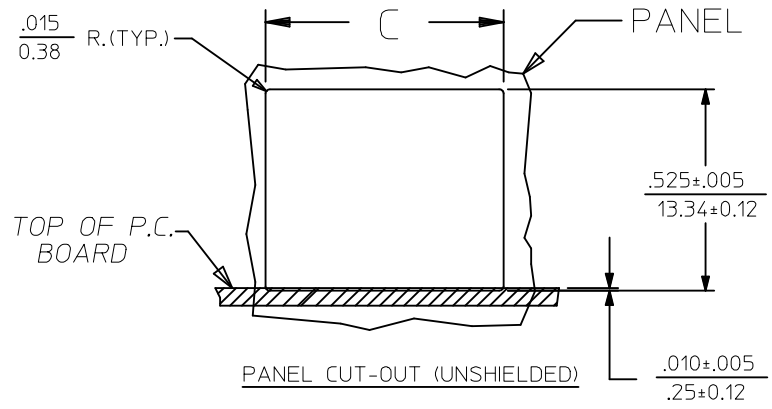
8 POSITION LOADED 10 SIZE SHOWN



OPTIONAL FLANGE
USED FOR FLUSH
MODULAR JACK



PEG DETAIL
SCALE 8:1



HOUSING SIZE	CIRCUIT SIZE	DIM. A	DIM. B	DIM. C
8	10	.600±.005 (15.24±0.13)	.450±.005 (11.43±0.13)	.620±.005 (15.75±0.13)
8	8	.600±.005 (15.24±0.13)	.350±.005 (8.89±0.13)	.620±.005 (15.75±0.13)
8	4	.600±.005 (15.24±0.13)	.150±.005 (3.81±0.13)	.620±.005 (15.75±0.13)
8	6	.600±.005 (15.24±0.13)	.250±.005 (6.35±0.13)	.620±.005 (15.75±0.13)
6	6	.520±.005 (13.21±0.13)	.250±.005 (6.35±0.13)	.540±.005 (13.72±0.13)
6	4	.520±.005 (13.21±0.13)	.150±.005 (3.81±0.13)	.540±.005 (13.72±0.13)
6	2	.520±.005 (13.21±0.13)	.050±.005 (1.27±0.13)	.540±.005 (13.72±0.13)

SEE SHEET 1

EC NO: UCP2009-0740

DRWN: JLOSTEME / ER 2008/09/29

CHKD: JBEL 2008/10/03

APPR: F SMITH 2008/10/03

REV

DESCRIPTION

QUALITY SYMBOLS
=0
=0

GENERAL TOLERANCES (UNLESS SPECIFIED)
mm INCH
4 PLACES ± --- ± ---
3 PLACES ± --- ± .010
2 PLACES ± 0.25 ± ---
1 PLACE ± --- ± ---
ANGULAR ± 1/2°
DRAFT WHERE APPLICABLE
MUST REMAIN
WITHIN DIMENSIONS

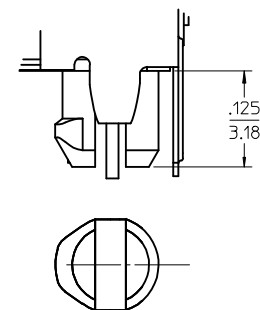
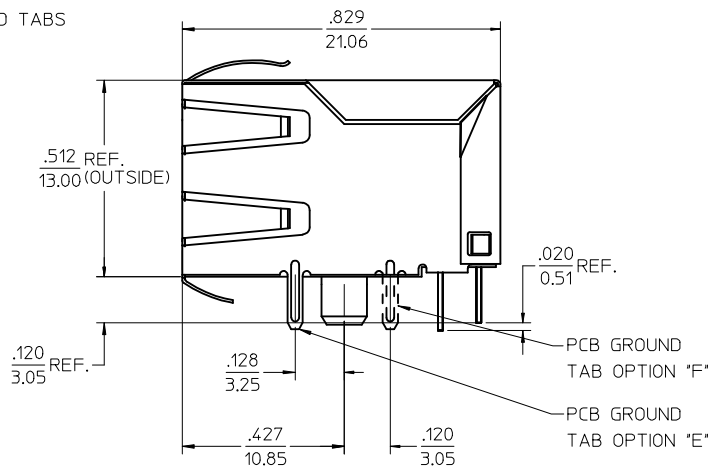
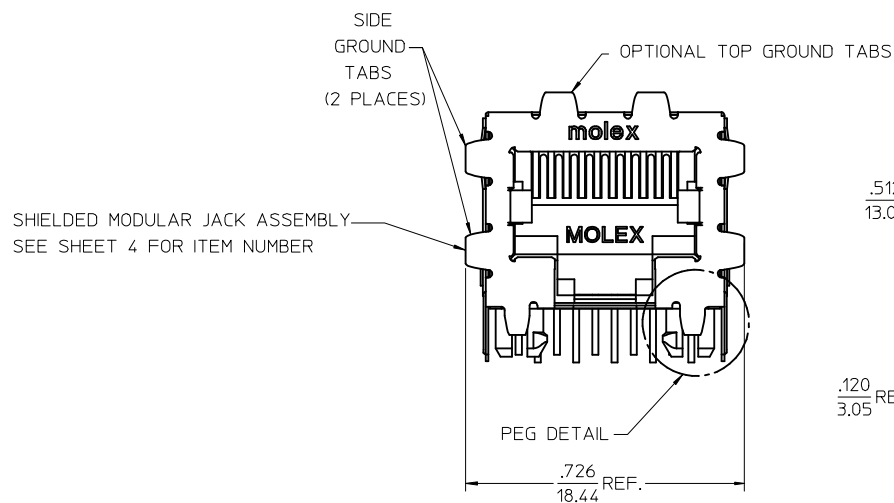
DIMENSION STYLE
IN/MM
DRAWN BY DATE
JTR 1993/06/23
CHECKED BY DATE
JTR 1993/06/23
APPROVED BY DATE
RAS 1993/06/23
MATERIAL NO.
DOCUMENT NO.
SHEET NO.
2 OF 6

SCALE
4:1
DESIGN UNITS
INCH
THIRD ANGLE PROJECTION

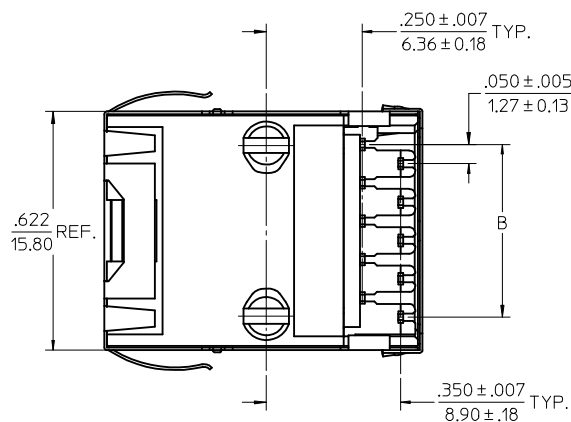
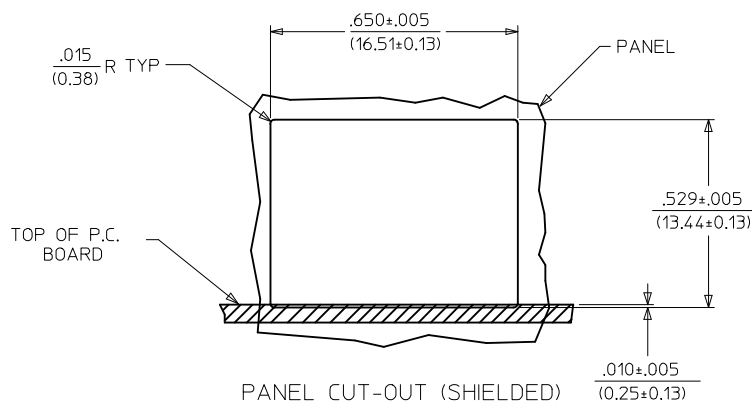
TITLE
LOW PROFILE RIGHT ANGLE
MODULAR JACK ASSEMBLY
MOLEX INCORPORATED
SDA-43249

MODULAR JACK W/ .007" THICK SHIELD AND OPTIONAL GROUND TABS

8 LOADED 10 VERSION SHOWN WITH GROUND TAB OPTIONS "D" AND "E"



PEG DETAIL
SCALE 8:1



DESCRIPTION OF GROUND TAB OPTIONS:
(SEE SHEET 4 FOR AVAILABLE COMBINATIONS OF OPTIONS)

GROUND TAB OPTION	DESCRIPTION
A	NO GROUND TABS
B	TOP TABS ONLY
C	STAGGERED SIDE TABS
D	TOP AND SIDE TABS
E	PCB GROUND TAB IN FRONT POSITION
F	PCB GROUND TAB IN REAR POSITION

HOUSING SIZE	CIRCUIT SIZE	B
8	10	.450 ± .005 11.43 ± 0.13
8	8	.350 ± .005 8.89 ± 0.13

SEE SHEET 1
EC NO: UCP2009-0740
DRWN: JKLOSTEMEIER 2008/09/29
CHKD: JELL 2008/10/03
APPR: FSMITH 2008/10/03

QUALITY SYMBOLS
▽=0
▽=0

GENERAL TOLERANCES (UNLESS SPECIFIED)

	mm	INCH
4 PLACES ±	± .010	± .004
3 PLACES ±	± .010	± .004
2 PLACES ±	± .025	± .010
1 PLACE ±	± .050	± .020

ANGULAR ± 1/2°

DRAFT WHERE APPLICABLE
MUST REMAIN WITHIN DIMENSIONS

DIMENSION STYLE
IN/MM

DRAWN BY DATE
JTR 1993/06/23

CHECKED BY DATE
JTR 1993/06/23

APPROVED BY DATE
RAS 1993/06/23

MATERIAL NO.
SEE SHEET 4

SIZE
C

SCALE
4:1

DESIGN UNITS
INCH

THIRD ANGLE PROJECTION

TITLE
LOW PROFILE RIGHT ANGLE
MODULAR JACK ASSEMBLY

MOLEX INCORPORATED

DOCUMENT NO.
SDA-43249

SHEET NO.
3 OF 6

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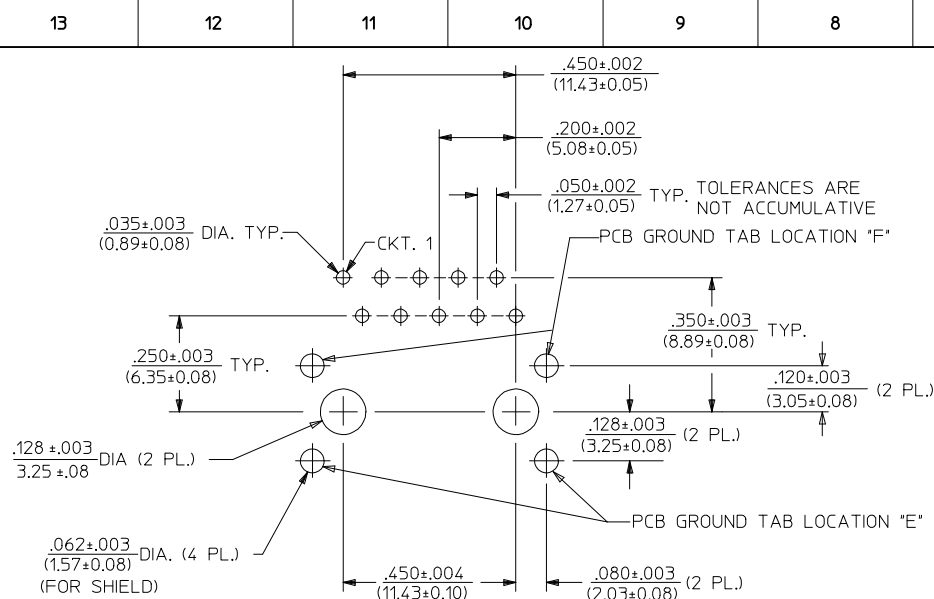
13	12	11	10	9	8	7	6	5	4	3	2	1
FLUSH MOUNT (UNSHIELDED)					SHIELDED, .007" THICK							
ASSEMBLY ITEM NUMBER	CONNECTOR SIZE	NUMBER OF CIRCUITS	TERMINAL PLATING OPTION		ASSEMBLY ITEM NUMBER	CONN. SIZE	NUMBER OF CIRCUITS	TERMINAL PLATING OPTION	SIDE/TOP PANEL GROUND TAB OPTION	PCB GROUND TAB OPTION		PACKAGING OPTION
43249-8001	8	10	A		43249-8900	8	10	A	A	E		TRAY
43249-8004	8	8	A		43249-8901	8	10	A	B	E		TRAY
43249-8010	8	6	A		43249-8902	8	10	A	C	E		TRAY
43249-6001	6	6	A		43249-8903	8	10	A	D	E		TRAY
43249-6004	6	4	A		43249-8908	8	10	A	A	F		TRAY
43249-6007	6	2	A		43249-8909	8	10	A	B	F		TRAY

FLANGELESS (UNSHIELDED)			
ASSEMBLY ITEM NUMBER	CONNECTOR SIZE	NUMBER OF CIRCUITS	TERMINAL PLATING OPTION
43249-8101	8	10	A
43249-8102	8	10	B
43249-8104	8	8	A
43249-8105	8	8	B
43249-8116	8	6	A
43249-8119	8	4	A
43249-6101	6	6	A
43249-6104	6	4	A
43249-6107	6	2	A

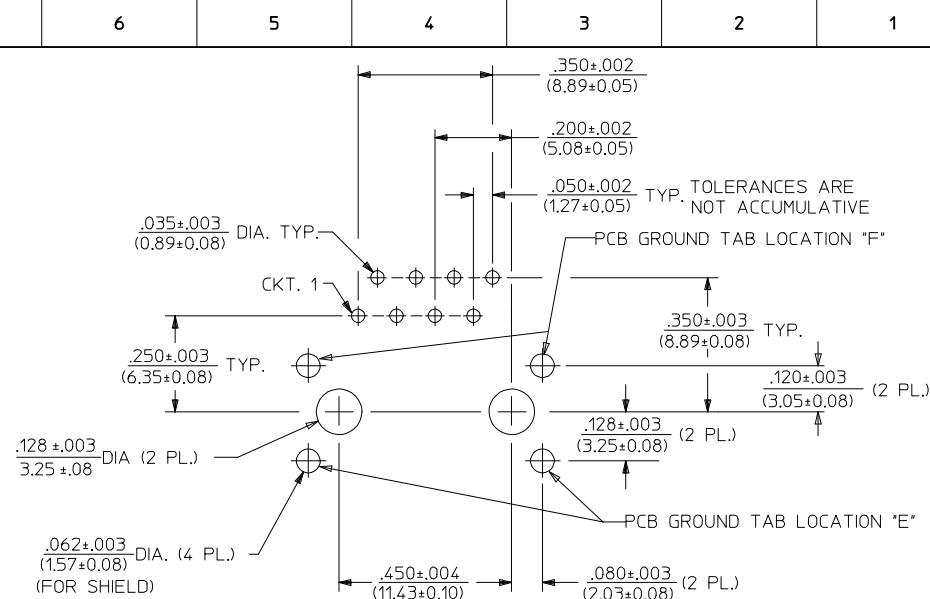
FLANGELESS (UNSHIELDED)			
(SHIPPED IN TUBES)			
43249-6501	6	6	A
43249-6504	6	4	A

SHIELDED, .007" THICK						
ASSEMBLY ITEM NUMBER	CONN. SIZE	NUMBER OF CIRCUITS	TERMINAL PLATING OPTION	SIDE/TOP PANEL GROUND TAB OPTION	PCB GROUND TAB OPTION	PACKAGING OPTION
43249-8900	8	10	A	A	E	TRAY
43249-8901	8	10	A	B	E	TRAY
43249-8902	8	10	A	C	E	TRAY
43249-8903	8	10	A	D	E	TRAY
43249-8908	8	10	A	A	F	TRAY
43249-8909	8	10	A	B	F	TRAY
43249-8910	8	10	A	C	F	TRAY
43249-8911	8	10	A	D	F	TRAY
43249-8916	8	8	A	A	E	TRAY
43249-8917	8	8	A	B	E	TRAY
43249-8918	8	8	A	C	E	TRAY
43249-8919	8	8	A	D	E	TRAY
43249-8920	8	8	B	A	E	TRAY
43249-8924	8	8	A	A	F	TRAY
43249-8925	8	8	A	B	F	TRAY
43249-8926	8	8	A	C	F	TRAY
43249-8927	8	8	A	D	F	TRAY

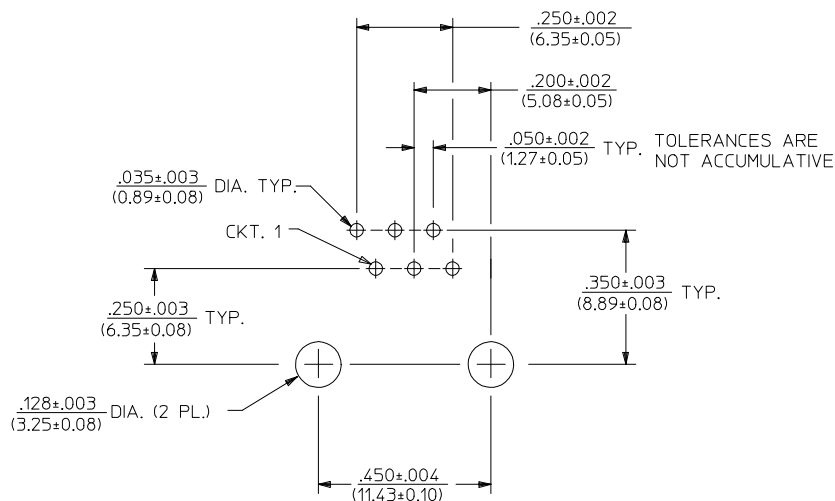
SEE SHEET 1 EC NO: UCP2009-0740 DRAWN: JLOSTEME 08/08/09/29 CHKD: JBELL 08/08/10/03 APPR: FSWITH 08/08/10/03	DESCRIPTION	QUALITY SYMBOLS	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE IN/MM		SCALE 4:1	DESIGN UNITS INCH	THIRD ANGLE PROJECTION		
	▽=0 ▽=0			mm	INCH	DRAWN BY JTR	DATE 1993/06/23	TITLE LOW PROFILE RIGHT ANGLE MODULAR JACK ASSEMBLY			
			4 PLACES	±---	±---	CHECKED BY	DATE				
			3 PLACES	±---	±.010	JTR	1993/06/23				
			2 PLACES	±0.25	±---	APPROVED BY	DATE				
			1 PLACE	±---	±---	RAS	1993/06/23				
	ANGULAR ±1/2°		MATERIAL NO.		DOCUMENT NO.		SHEET NO.				
DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SEE CHART		SDA-43249		4 OF 6					
REV			SIZE C THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION								



PC BOARD LAYOUT FOR SIZE 8, 10 CIRCUIT
(COMPONENT SIDE OF BOARD)



PC BOARD LAYOUT FOR SIZE 8, 8 CIRCUIT
(COMPONENT SIDE OF BOARD)

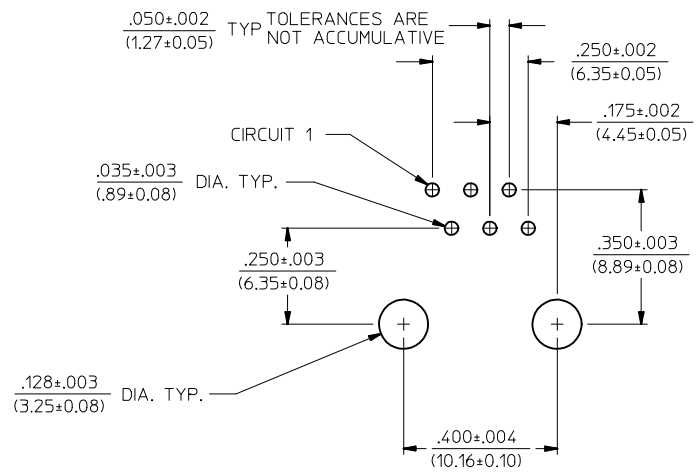


PC BOARD LAYOUT FOR SIZE 8, 6 CIRCUIT
(COMPONENT SIDE OF BOARD)

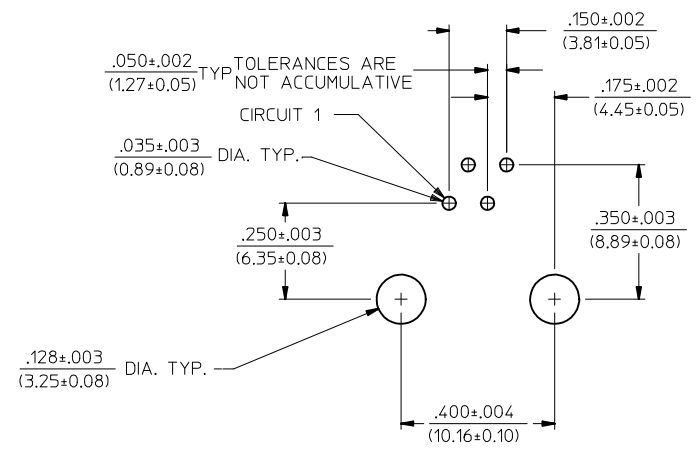
NOTES:
1. RECOMMENDED PCB THICKNESS: .062 ± .005 / (1.57 ± 0.13)

SEE SHEET 1 EC NO: UCP2009-0740 DRWN: KLOSTEMEIER 2008/09/29 CHKD: JBEL 2008/10/03 APPR: FSMITH 2008/10/03	REV	DESCRIPTION	QUALITY SYMBOLS ▽=0 ▽=0	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE IN/MM		SCALE 4:1	DESIGN UNITS INCH	THIRD ANGLE PROJECTION	TITLE LOW PROFILE RIGHT ANGLE MODULAR JACK ASSEMBLY		
					mm	INCH	DRAWN BY JTR	DATE 1993/06/23	MATERIAL NO.				
				4 PLACES	± ---	± ---	CHECKED BY JTR	DATE 1993/06/23	DOCUMENT NO.				
				3 PLACES	± ---	± .010	APPROVED BY RAS	DATE 1993/06/23	SHEET NO.				
				2 PLACES	± 0.25	± ---	SEE SHEET 4		SDA-43249				
				1 PLACE	± ---	± ---	SIZE		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION				
				ANGULAR ±1/2°									
				DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS									

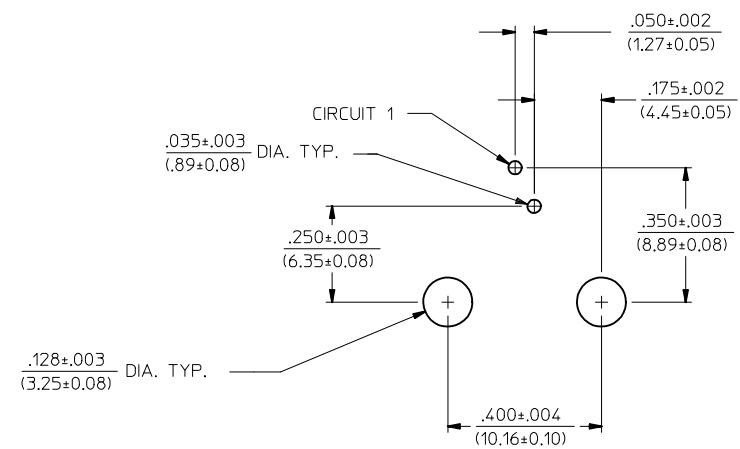
13 12 11 10 9 8 7 6 5 4 3 2 1



PC BOARD LAYOUT FOR SIZE 6, 6 CIRCUIT
(COMPONENT SIDE OF BOARD)



PC BOARD LAYOUT FOR SIZE 6, 4 CIRCUIT
(COMPONENT SIDE OF BOARD)



PC BOARD LAYOUT FOR SIZE 6, 2 CIRCUIT
(COMPONENT SIDE OF BOARD)

NOTES:
1. RECOMMENDED PCB THICKNESS: .062±.005/(1.57±0.13)

SEE SHEET 1 EC NO: UCP2009-0740 DRWN: KLOSTEMEIER 2008/09/29 CHKD: JELL 2008/10/03 APPR: FSMITH 2008/10/03 K1	QUALITY SYMBOLS ▽=0 ▽=0	DESCRIPTION	REV	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE IN/MM		SCALE 4:1	DESIGN UNITS INCH	 THIRD ANGLE PROJECTION		
				DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS	mm	INCH	DRAWN BY JTR	DATE 1993/06/23	TITLE LOW PROFILE RIGHT ANGLE MODULAR JACK ASSEMBLY			
					4 PLACES ± --- ± ---	± ---	CHECKED BY	DATE				
					3 PLACES ± --- ± .010	± ---	JTR	1993/06/23				
					2 PLACES ± 0.25 ± ---	± ---	APPROVED BY	DATE				
					1 PLACE ± --- ± ---	± ---	RAS	1993/06/23				
				ANGULAR ±1/2°		MATERIAL NO.		DOCUMENT NO.			SHEET NO.	
						SEE SHEET 4		SDA-43249			6 OF 6	
				THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION								